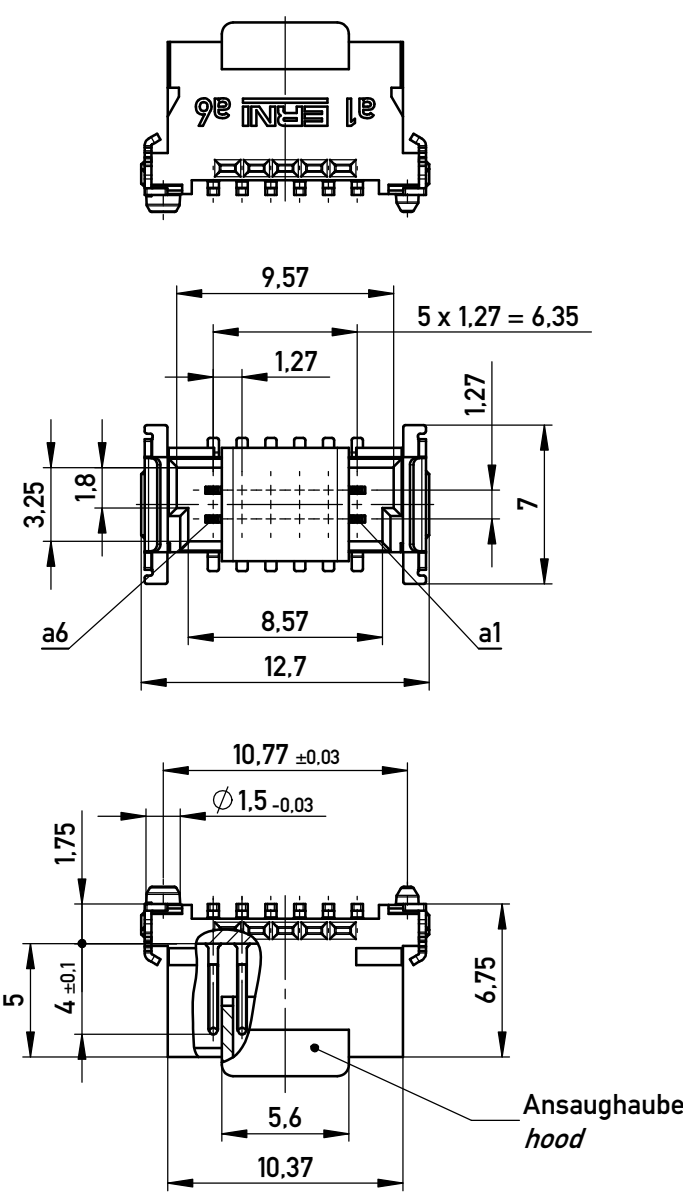




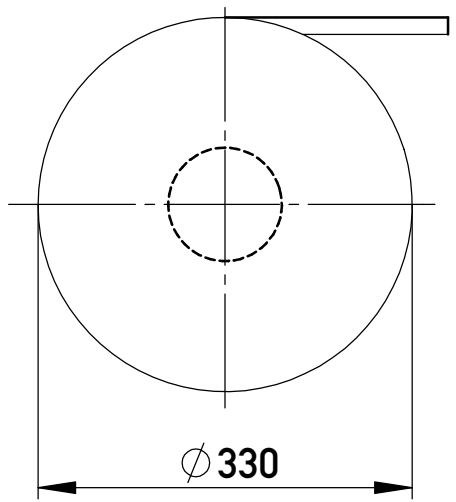
Anforderungsstufe 1
Performance Level 1

Kontaktbereich vergoldet
Mating Area gold plating

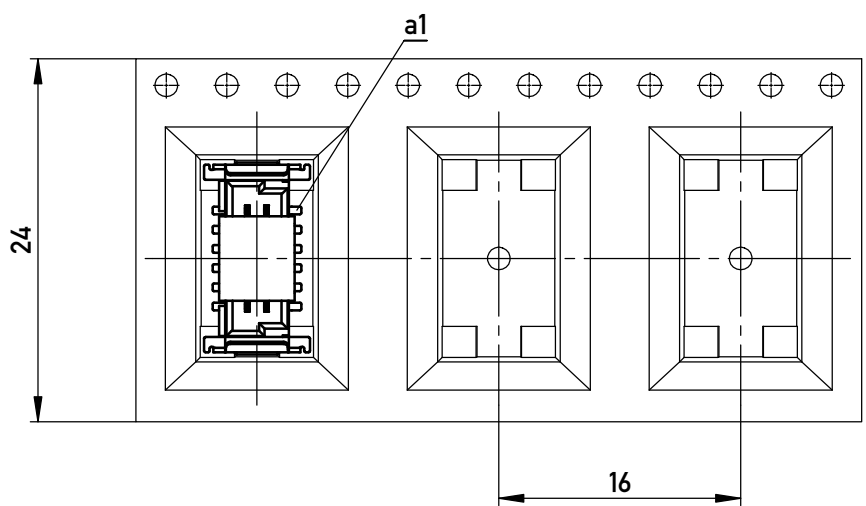
Anschlussbereich verzinkt 4-6 µm
Terminal Area 4-6 µm tin plating

Koplanarität der Anschlüsse ≤ 0,1 mm
Coplanarity Area of Termination ≤ 0,1 mm

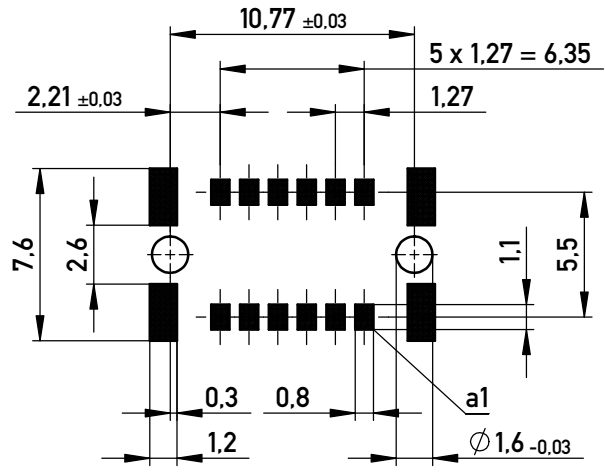
Verpackt im Gurt nach DIN IEC 60286-3
Tape on Reel Packaging according to DIN IEC 60286-3
Verpackungseinheit: 280 Stück
Packaging unit: 280 pcs



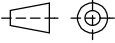
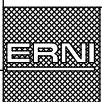
Abspulrichtung - Reel off Direction



Leiterplatten-Layout Vorschlag für SMT
PCB-Layout Proposal for SMT



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					BA 8-13 - 8mm Bauhöhe				
					type 8-13 - Low Profile				
Information:				Tolerances	 All Dimensions in mm	Scale 3:1			
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						Messerl. SMC-Q 12-SMD-BA8-13			
						Male SMC-Q 12-SMD-type8-13			
				www.ERNI.com		100103440002		K	
								A3	
d		25.02.2014				Class		SMCQ	
Index		Date							